

CALENDAR

Upcoming: October 8–13 8th IUMRS Intl. Conf. on Advanced Materials, IUMRS/MRS-J; October 9–10 Conf. on Electronic Applications for Organic Materials, Endorsed; November 10–13 Intl. Symp. on Clusters and Nano-Assemblies: Physical and Biological Systems, Endorsed.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the July 2003 MRS BULLETIN for September 2003 Calendar entries.

OCTOBER 2003

4–9 Conf. on Fundamental Aspects of Surface Science: Manufacture and Properties of Structures with Reduced Dimensionality, *Kerkrade, The Netherlands*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

5–9 87th OSA Annual Meeting and Laser Science Conf., *Tucson, AZ*. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings.

5–10 7th Intl. Conf. on Laser Ablation COLA03, *Hersonissos, Greece*. Magda Kokolaki, IESL, P.O. Box 1527, Vassilikia Vouto, Heraklion, Greece; 30-281-0391315; fax 30-281-0391318; e-mail cola03@iesl.forth.gr; www.iesl.forth.gr/cola03.

5–10 Intl. Conf. on Silicon Carbide and Related Materials 2003 (ICSCRM03), *Lyon, France*. ICSCRM 2003, ENSEEG/INPG, 1130 rue de la Piscine, Domaine Universitaire, 38402 Saint Martin d'Hères France; e-mail: ICSCRM2003@inpg.fr; http://icscrm2003.inpg.fr.

7–10 Advanced Technology Workshop/Exhibition on Optoelectronics Device Packaging, *Palo Alto, CA*. IMAPS, 611 2nd Street N.E., Washington, DC, 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

7–12 Electromagnetic Interactions with Nucleons and Nuclei: EuroConf. on Hadron Structure Viewed with Electromagnetic Probes, *Santorini, Greece*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

8–13 8th IUMRS Int. Conf. on Advanced Materials, *Yokohama, Japan*. Prof. Atsushi Suzuki, and Ms. Kyoko Yoshimi, c/o Prof. A. Suzuki's Laboratory, Faculty of Environment and Information Sciences & Materials Science Department, Yokohama National University, 79-7 Tokiwadai, Hodogaya-ku, Yokohama 240-8501, Japan; tel./fax 81-45-339-4305; e-mail icam2003@ynu.ac.jp; www.mrs-j.org. IUMRS/MRS-J.

9–10 ▼ University of Delaware Conf. on Electronic Applications for Organic Materials, *Newark, DE*. Joe Tanner, University of Delaware, Newark, DE, 19716; 302-831-6316; fax 302-831-8179; e-mail tanner@udel.edu; www.engr.udel.edu/outreach/ElectroOrganicMaterials.html. Endorsed.

9–12 ▼ 11th Foresight Conf. on Molecular Nanotechnology, *San Francisco, CA*. James Spencer, Foresight Institute, Box 61058, Palo Alto, CA, 94306; 650-917-1122; fax 650-917-1123; e-mail jtsponce@syr.edu; www.foresight.org.

12–14 19th Annual Conf. of the Intl. Titanium Assoc., *Monterey, CA*. ITA, 350 Interlock Blvd., Ste. 390, Broomfield, CO 80021-3485; 303-404-2221; fax 303-404-9111; e-mail conference@titanium.org; www.titanium.org.

12–16 3rd Intl. Conf. on Bulk Metallic Glasses (Bulk Amorphous Alloys), *Beijing, China*. W.H. Wang, Inst. of Physics, Chinese Academy of Sciences, P.O. Box 603, Beijing 100080, P.R. China; 86-10-8264-9198; fax 86-10-8264-0223; e-mail Whw@aphy.iphy.ac.cn; www.iphy.ac.cn.

12–17 204th Meeting of the Electrochemical Society, *Orlando, FL*. The Electrochemical Society, 65 S. Main St., Bldg. D, Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/meetings.htm.

13–16 ASM Materials Solutions Conf. and ASNT Fall Meeting, *Pittsburgh, PA*. ASM Intl., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org/materialsolutions.

13–16 Intl. Congress on Applications of Lasers and Electro-Optics ICALEO, *Jacksonville, FL*. LIA, 13501 Ingenuity Drive, Suite 1, Orlando, FL, 32826; 800-345-2737; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.icaleo.org.

13–18 ▼ First Intl. Meeting on Applied Physics (APHYS-2003), *Badajoz, Spain*. www.formatex.org/aphys2003/aphys2003.htm.

15–17 ▼ Gorham Conf. on Sintered and Bonded NdFeB Magnets, *Detroit, MI*. Deedra Manter, Gorham Technologies, 209 Mosher Road, Gorham, ME, 04038; 207-892-5445; fax 207-892-2210; e-mail damanter@gorhamtech.com; www.gorhamtech.com.

15–17 Light Emitting Diodes 2003, *San Diego, CA*. Intertech USA, Intertechusa, 207-781-9800; fax 207-781-2150; e-mail info@intertechusa.com/leds.html.

15–18 Intl. Meeting on Applied Physics, *Badajoz, Spain*. www.formatex.org/aphys2003/aphys2003.htm.

16–17 ▼ Frontiers in Inorganic Polymers, *Philadelphia, PA*. James Mark, University of Cincinnati, 513-556-9292; e-mail markje@mail.uc.edu; chemistry.org/shortcourses.

19–22 55th Pacific Coast Regional and Basic Science Division Meeting of the ACerS, *Oakland, CA*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org; www.ceramics.org.

19–22 Natl. Educators Workshop: Update 2003, *Newport News, VA*. Jim Jacobs, 757-823-8109; fax 757-823-8215; e-mail dplacaire@nsu.edu; mst-online.nsu.edu/new.

19–22 UNITECR Congress—8th Biennial Worldwide Congress on Refractories, *Osaka, Japan*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org; www.ceramics.org.

20–23 19th Annual Intl. Conf. on Contaminated Soils, Sediments, and Water, *Amherst, MA*. D. Leonard, Environmental Health Sciences, N344 Morrill, Univ. of Massachusetts, Amherst, MA 01003; 413-545-1239; fax 413-545-4692; e-mail dleonard@schoolph.umass.edu; www.UMassSoils.com.

20–23 Intl. Integrated Reliability Workshop, *S. Lake Tahoe, CA*. Al Strong, IBM Microelectronics, mail #96, 1000 River Road, Essex Junction, VT, 05452; e-mail astrong@us.ibm.com; www.irps.org/irw.

21–23 Advanced Metallization Conference (AMC) 2003, *Montreal, Canada*. UC Berkeley Extension, Continuing Education in Engineering, 1995 University Avenue, Berkeley, CA 94720, USA; 510 642-4151; fax 510 642-6027; e-mail course@unx.berkeley.edu; www.unex.berkeley.edu/eng/metal/.

22–24 ▼ Intl. Congress on Materials Science and Nanotechnologies (NANMAT 2003), *Brussels, Belgium*. Rene Krapez, European Academy of Sciences, 32-2-234-63-83; fax 32-2-234-79-11; e-mail eurasc@skynet.be; www.crmus.org.

23–24 10th Sampling and On-Site Analysis Conf., *Pittsburgh, PA*. H. Nowicki, Conf. Chairperson; Professional Analytical and Consulting Services, 409 Meade Dr., Coraopolis, PA 15108; 724-457-6576; fax 724-457-1214; e-mail HNpacs@aol.com; www.pacsllabs.com.

24–26 Thermal Management for High-Performance Computing and Wireless Applications, *Palo Alto, CA*. IMAPS, 611 2nd Street N.E., Washington, DC, 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

26–29 ▼ 2nd Brazilian-MRS Meeting, *Rio de Janeiro, Brazil*. SBPMat, Caixa Postal 38090, Gávea, CEP 22451-970, Rio de Janeiro, Brazil; e-mail sbpmat@rdc.puc-rio.br; www.sbpmat.org.br/2meeting.

NOVEMBER 2003

3–7 50th AVS Intl. Symposium, *Baltimore, MD*. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@avs.org; www.avs.org.

3–7 ▼ Intl. Symp. on Optical Memory 2003, *Nara, Japan*. ISOM2003 Secretariat, 5-16-9 Honkomagome, Bunkyo-ku, Tokyo, Japan; 81-3-5814-5800; fax 81-3-5814-5823; e-mail sakasita@bcasj.or.jp; www.isom.jp.

3–8 3rd Intl. Symposium on Slow Dynamics in Complex Systems, *Sendai, Japan*. M. Tokuyama, Inst. of Fluid Science, Tohoku Univ., 2-1-1 Katahira, Aoba-ku, Sendai 980-8577, Japan; phone and fax 81-22-217-5327; e-mail tokuyama@ifs.tohoku.ac.jp; www.ifs.tohoku.ac.jp/slow-dynamics.

5–7 Intl. Conf. on Materials Characterization, *Santa Fe, NM, Canada*. UC Berkeley Extension, Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk.

6 ▼ IMAPS—Garden State Chapter—Fall Packaging Symp. on Thermal Management Packaging Applications, *Murray Hill, NJ*. Mike Salloum, 732-572-5033; fax 732-549-1388; e-mail msalloum@rdcircuits.com; www.imaps.org/chapters/garden.htm.

9–12 TMS Fall Meeting, *Chicago, IL*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org.

10–13 ▼ 14th IAS Steelmaking Conf., *San Nicolas, Argentina*. Cristian Genzano, Instituto Argentino de Siderur, Av. Central y Calle 19 Oeste, 2900 San Nicolas, Buenos Aires, Argentina; 54-3461-468083; fax 54-3461-462989; e-mail genzano@siderurgia.org.ar.

10–13 Intl. Sym. on Clusters and Nano-Assemblies: Physical and Biological Systems, *Richmond, VA*. ISCANA, c/o Dr. P. Jena, Physics Dept., Virginia Commonwealth University, Richmond, VA 23284-2000; 804-828-8991; fax 804-828-7073; e-mail iscana@vcu.edu or bkrao2vcu.edu; www.vcu.edu/ISCANA. Endorsed.

16–20 7th Intl. Conf. on Atomically Controlled Surfaces, Interfaces, and Nanostructures, *Nara, Japan*. M. Katayama, Dept. of Electronic Engineering, Graduate School of Engineering, Osaka Univ., Ste. 565-0871, Osaka, Japan; 81-6-6879-7776; fax 81-6-6879-7780; e-mail acsin7@ele.eng.osaka-u.ac.jp; www.ele.eng.osaka-u.ac.jp/acsin7.

16-20 ▼ 36th Intl. Symp. of Microelectronics, *Boston, MA*. Delip Bokil, Nanmark Associates, 611 2nd Street, N.E., Washington, D.C.; 202-548-4001; e-mail doug.bokil@etest.com; www.imaps.org.

16-21 Conf. on Micro-Mechanical Properties of Biomaterials, *Tomar, Portugal*. Engineering Conf. Intl., 6 Metro Tech Ctr., Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/3ay.html.

18-20 Conf. on Magnesium Alloys and Their Applications, *Wolfsburg, Germany*. M. Schmieder, MatInfo GmbH, Hamburger Allee 26, 60486 Frankfurt, Germany; 49-69-7917-756; fax 49-69-7917-733; e-mail expo@dgm.de; www.dgm.de/magnesium.

24-25 European Coatings Conferences: Modern Coatings for Plastics, *Berlin, Germany*. Amanda Beyer, Vincentz Network, Schiffgraben 43, D-30175 Hannover, Germany; 49-511-99-10-271; fax 49-511-99-10-279; e-mail amanda.beyer@coatings.de; www.coatings.de.

30-3 Copper Conf., *Santiago, Chile*. G. Lagos, Pontificia Univ. Catolica de Chile, Dept. de Ingenieria Quimica, Vicuna Mackenna 4860, Santiago 6904411, Chile; 56-2-686-5927; fax 56-2-686-5805; e-mail inf@cu2003.cl.

DECEMBER 2003

1-5 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

3-4 ▼ Intl. Forum on MicroNano Integration-MINIT, *Potsdam, Germany*. Harald Knobloch, VDI/VDE-IT, 49-3328/435-143; e-mail minit@vdi-vde-it.de; www.minit.org.

4-5 European Coatings Conferences: The Power of Ink Jet Materials, *Berlin, Germany*. Amanda Beyer, Vincentz Network, Schiffgraben 43, D-30175 Hannover, Germany; 49-511-99-10-271; fax 49-511-99-10-279; e-mail amanda.beyer@coatings.de; www.coatings.de.

8-11 ▼ Second Intl. Conf. of the African Materials Research Society (MRS-Africa), *Johannesburg, South Africa*. Yunus Ballim, School of Civil and Environmental Engineering, University of the Witwatersrand, Private Bag 3, Wits 2050, South Africa; fax 2711-3391762; e-mail ballim@civil.wits.ac.za; www.wits.ac.za/AfricaMRSconf2.

10-12 ▼ 2003 Intl. Semiconductor Device Research Symp., *Washington, D.C.* Kenneth Jones, e-mail kajones@arl.army.mil; www.ece.umd.edu/isdrs.

JANUARY 2004

5-10 Winter Conf. on Plasma Spectrochemistry, *Ft. Lauderdale, FL*. R. Barnes, ICP Information Newsletter, P.O. Box 666, Hadley, MA 01003-0666; 413-256-8942; fax 413-256-3746; e-mail winterconf@chem.umass.edu; www.chem.umass.edu/WinterConf2004.

24-28 ▼ 128th AAPT Natl. Meeting, *Miami, FL*. American Association of Physics Teachers, e-mail aapt-meet@aapt.org; www.aapt.org.

24-29 Photonics West 2004, *San Jose, CA*. SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org/Conferences/Calls/04/pw.

FEBRUARY 2004

22-27 ▼ 29th Annual Intl. Symp. on Microlithography, *Santa Clara, CA*. Marilyn Bennett, Texas Instruments Inc., e-mail spie@spie.org; www.spie.org/info/ml.

22-27 ▼ Dynamics of Disordered Materials on the Nanometer Scale, *Hanoi, Vietnam*. David Price, CNRS-CRMHT, Orleans, France; www.engconfintl.org/4ah.html.

25-27 ▼ SIAM Conf. on Parallel Processing for Scientific Computing, *San Francisco, CA*. Society for Industrial and Applied Mathematics, 3600 Univ. City Science Center, Philadelphia, PA, 19104-2688; 215-382-9800; e-mail meetings@siam.org; www.siam.org/meetings/pp04.

MARCH 2004

1-2 ▼ 12th Intl. Activated Carbon Conf., *Mexico City, Mexico*. Henry Nowicki, PACS Testing and Consulting, 724-457-6576; fax 724-457-1214; e-mail HNpacs@aol.com; www.pacs-slabs.com.

7-10 ▼ Materials for Advanced Metallization, *Leuven, Belgium*. G. Beyer, IMEC, Kapeldreef 75, Leuven, Belgium; fax 32-16-281-214; e-mail MAM2004@imec.be; www.imec.be/kiosk/MAM 2004.

7-12 2004 Pittsburgh Conf. on Analytical Chemistry and Applied Spectroscopy (PITTCON 2004), *Chicago, IL*. Pittcon, 412-825-3220; fax 412-825-3224; e-mail program@pittcon.org; www.pittcon.org.

14-18 TMS Annual Meeting, *Charlotte, NC*. Programming Dept., The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail raabe@tms.org; www.tms.org.

18-19 European Coatings Conferences: Polyurethanes for High Performance Coatings III, *Berlin, Germany*. Amanda Beyer, Vincentz Network, Schiffgraben 43, D-30175 Hannover, Germany; 49-511-99-10-271; fax 49-511-99-10-279; e-mail amanda.beyer@coatings.de; www.coatings.de.

22-26 ▼ American Physical Society (APS) March 2004 Meeting, *Montreal, Canada*. Donna Baudrau, 301-209-3286; e-mail baudrau@aps.org; www.aps.org/meet/calendar.html.

25-27 European Thermoforming Conf., *Viareggio, Italy*. Yetty Pauwels, Society of Plastics Engineers, Bistkapellei 44, Antwerp, Belgium; 32-3-541-77-55; fax 32-3-541-84-25; e-mail spe.europe@pi.be; www.4spe.org/semconf/conferences/0403eurothermo.htm.

31-4 4th Intl. Conf. on High Temperature Capillarity, *Sanremo-Genoa, Italy*. Conf. Secretariat IENI-CNR, via de Marini, 6, 16149, Genoa, Italy; fax 39 010 6575 700; e-mail htc4@ge.ieni.cnr.it; www.ieni.cnr.it/conferences.htm. **Endorsed.**

APRIL 2004

12-16 MRS Spring Meeting/ ICEM 2004, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS/UMRS.**

18-21 106th ACerS Meeting, *Indianapolis, IN*. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org.

26-28 ▼ MEMS IV—4th Annual ASME MEMS Technology Seminar, *Los Angeles, CA*. Jennifer Burns, ASME International, 3 Park Avenue, 23S1, New York, NY, 10016; 212-591-7423; fax 212-591-7143; e-mail burns@asme.org; www.asme.org/education/techsem/mems.

26-30 ▼ Photonics Europe: Showcasing the Age of Light, *Strasbourg, France*. Society of Photo-Optical Instrumentation Engineers, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org/info/europe.

MAY 2004

1-4 ▼ American Physical Society (APS) April 2004 Meeting, *Denver, CO*. Donna Baudrau, 301-209-3286; e-mail baudrau@aps.org; www.aps.org/meet/calendar.html.

9-14 205th Meeting of the Electrochemical Society, *San Antonio, TX*. The Electrochemical Society, 65 S. Main St., Bldg. D, Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/meetings.htm.

16-19 Magneto-Optical Recording Intl. Symposium (MORIS 2004), *Yokohama, Japan*. MORIS 2004 Secretariat, Proactive Convention Co., Ltd., Eiko Bldg.2F, 93 Edomachi, Chuo-ku, Kobe 650-0033, Japan; 81-78-334-6661; fax 81-78-334-6662; e-mail moris2004@pac.ne.jp; www.pac.ne.jp/moris2004.

Endorsed.

16-21 7th World Biomaterials Congress, *Sydney, Australia*. Biomaterials Congress Managers, GPO Box 128, Sydney NSW 2001, Australia; 61-2-9262-2277; fax 61-2-9262-3135; e-mail biomaterials@tourhosts.com.au; www.tourhosts.com.au/biomaterials.

24-28 E-MRS Spring Meeting, *Strasbourg, France*. European Materials Research Society, 23 rue du Loess, B.P. 20, 67037 Strasbourg Cedex 02, France; 33-3-88-10-6372; 33-3-88-10-6293; e-mail emrs@phase.c-strasbourg.fr; www-emrs.c-strasbourg.fr. **E-MRS.**

30-4 3rd Intl. Conf. on Computational Modeling and Simulation of Materials, *Acireale, Italy*. Technagroup, P.O. Box 174, Faenza, Italy; +0546-22461; fax +0546-664138; e-mail info@technagroup.it; www.technagroup.it/modeling.htm.

30-4 ▼ 12th Intl. Conf. on Metal-Organic Vapor Phase Epitaxy, *Lahaina, HI*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org.

JUNE 2004

7-8 European Coatings Conferences: Smart Coatings III, *Berlin, Germany*. Amanda Beyer, Vincentz Network, Schiffgraben 43, D-30175 Hannover, Germany; 49-511-99-10-271; fax 49-511-99-10-279; e-mail amanda.beyer@coatings.de; www.coatings.de.

13-17 2004 Intl. Conf. on Powder Metallurgy & Particulate Materials, *Chicago, IL*. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org.

JULY 2004

11-15 9th Intl. Conf. on the Structure of Non-Crystalline Materials, *Corning and Alfred, NY*. A.N. Cormack, New York State College of Ceramics at Alfred Univ., 2 Pine St., Alfred, NY 14802; fax 724-871-2980; e-mail cormack@alfred.edu; nyscc.alfred.edu/NCM9.

19-23 Intl. Workshop on Nitride Semiconductors, *IWN04, Pittsburgh, PA*. Materials Research Society, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

25-30 ▼ 27th Intl. Conf. on the Physics of Semiconductors (ICPS-27), *Flagstaff, AZ*. Fernando Ponce, Arizona State University, Flagstaff, AZ; e-mail ponce@asu.edu; www.icps2004.org.

AUGUST 2004

23-27 ▼ 3rd Intl. Conf. on HWCVD (Cat-CVD) Process, *Utrecht, Netherlands*. Ruud Schropp, Utrecht University, Debye Inst. Princetoneplein 5, Utrecht, The Netherlands; 31-30-253-3170; fax 31-30-254-3165; e-mail R.E.I.Schropp@phys.uu.nl; www.hwcvd.nl.

23-27 ▼ 2004 IEEE Intl. Ultrasonics, Ferroelectrics, and Frequency Control 50th Anniversary Joint Conf., *Montreal, Canada*. R. Michael Garvey, Symmetricom, 34 Tozer Road, Beverly, MA; 01915-5510; 978-232-1417; fax 978-927-4099; e-mail rmgarvey@symmetricom.com; www.ieee-uffc.org.

SEPTEMBER 2004

5-10 Intl. Conf. on Polycrystalline Semiconductors—POLYSE 2004, *Potsdam, Germany*. Norbert Nickel, Hahn-Meitner-Institut Berlin, Kekulestr. 5, Berlin, Germany; 49-30-67053-301; fax 49-30-67053-333; e-mail nickel@hmi.de.

12-15 5th Intl. Conf. on High Temperature Ceramic Matrix Composites, *Seattle, WA*. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org.

19-23 10th Intl. Symposium on Superalloys, *Champion, PA*. TMS Meeting Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/Meetings/Specialty/Superalloys2004/SuperalloysHome.html.

21-24 Intl. Conf. on Semi Solid Processing of Alloys and Composites, S2P 2004, *Limassol, Cyprus*. Carol Garofoli, Worcester Polytechnic Institut, 100 Institute Road, Worcester, MA, 01609-2280; 1-508-831-5592; fax 1-508-831-5993; e-mail s2p@wpi.edu; www.wpi.edu/News/Conf/S2P.

OCTOBER 2004

3-8 206th Meeting of the Electrochemical Society, *Honolulu, HI*. The Electrochemical Society, 65 S. Main St., Bldg. D, Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/meetings.htm.

17-24 ▼ PM2004 Powder Metallurgy World Congress and Exhibition, *Vienna, Austria*. EPMA, Old Bank Buildings, Bellstone, Shrewsbury, United Kingdom, 44-1743-248899; fax 44-0-1743-362968; e-mail fh@epma.com; www.epma.com/pm_2004/technical_program.htm.

NOVEMBER 2004

14-16 37th IMAPS Annual Symposium on Microelectronics, *Long Beach, CA*. IMAPS, 611 2nd St., N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

15-19 51st AVS Intl. Symposium, *Anaheim, CA*. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsny@avs.org; www.avs.org.

29-3 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

DECEMBER 2004

6-8 Intl. Symp. on Advanced Materials and Processing, *Kharagpur, India*. A.K. Banthia, Indian Institute of Technology, Kharagpur, India, 91-3222-282274; e-mail akb@matssc.iitkgp.ernet.in; www.iitkgp.ernet.in/departments/home.php?deptcode=MS. □

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